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Customer No.: 31561 Application No.: 10/604,791 Docket No.: 9249-US-PA

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OCT 11-2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:	-)	
Application No.:	10/604,791	Ś	
Filed:	August 18, 2003	j	
For:	Semiconductor Package Module Manufacturing Method Thereof	and))	
Applicant:	Shih-Change Lee)	•
Examiner:	Nguyen, Cuong Quang)	•
Art Unit	2811)	

RESPONSE TO RESTRICTION REQUIREMENT

U.S. Patent and Trademark Office Commissioner for Patents 220 20th Street South Customer Window, Mail Stop <u>Amendment</u> Crystal Plaza Two, Lobby, Room 1B03 Arlington, Virginia 22202

Dear Sir:

The Restriction Requirement dated September 02, 2004 requires the Applicant to elect one species from Embodiment 1 described in Fig. 2-6, Embodiment 2 described in Fig. 7 and Embodiment 3 described in Fig. 8 of the invention.

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